

N-Channel 60 V (D-S) Super Junction Power MOSFET

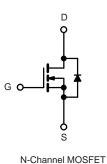
PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a		
60	0.0035 at V _{GS} = 10 V	130		
	0.005 at V _{GS} = 4.5 V	110		

FEATURES

- 175 °C Junction Temperature
- DT-Trench Power MOSFET
- Material categorization:







ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
Parameter	Symbol	Limit	Unit			
Gate-Source Voltage	V _{GS}	± 20	V			
Continuous Drain Current (T _{.I} = 175 °C) ^b	T _C = 25 °C	I-	130			
Continuous Diain Current (1 _J = 175 C) ²	T _C = 100 °C	l I _D	110 ^a			
Pulsed Drain Current	I _{DM}	480	А			
Continuous Source Current (Diode Conduction)	I _S	110 ^a				
Avalanche Current	I _{AS}	110				
Single Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AS}	500	mJ		
Maximum Power Dissipation	T _C = 25 °C	P _D	180	W		
Maximum Fower Dissipation	T _A = 25 °C	' Б	3 ^b , 8.5 ^{b, c}			
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 175	°C			

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Marrian de Ambienta	t ≤ 10 sec	D	15	18	°C/W		
Maximum Junction-to-Ambient ^a	Steady State	R_{thJA}	40	50			
Maximum Junction-to-Case	·	R _{thJC}	0.85	1.1			

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. $t \le 10 \text{ s}$.



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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit	
Static	l		L		l l		
Drain-Source Breakdown Voltage V _{DS}		$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$				V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1		2.5	V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
		V _{DS} = 48 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 48 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
		V _{DS} = 48 V, V _{GS} = 0 V, T _J = 175 °C			250		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	130			Α	
		V _{GS} = 10 V, I _D = 20 A		0.0035	0.0043		
D : 0	D	V _{GS} = 10 V, I _D = 20 A, T _J = 125 °C		0.0040	0.0050	0	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A, T _J = 175 °C		0.0045	0.0055	Ω	
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0050	0.0062		
Forward Transconductance ^b	9 _{fs}	$V_{DS} = 48 \text{ V}, I_{D} = 20 \text{ A}$		50		S	
Dynamic				•			
Input Capacitance	C _{iss}			3950			
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 48 \text{ V}, f = 1 \text{ MHz}$		670		pF	
Reverse Transfer Capacitance	C _{rss}			23			
Total Gate Charge ^c	Qg			67	78		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 48 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		12		nC	
Gate-Drain Charge ^c	Q _{gd}			8.5			
Turn-On Delay Time ^c	t _{d(on)}			10	20		
Rise Time ^c	t _r	V_{DD} = 48 V, R_L = 0.6 Ω		5	15		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 20$ A, V_{GEN} = 10 V, R_g = 2.5 Ω		55	70	ns	
Fall Time ^c	t _f			12	20		
Source-Drain Diode Ratings and Cha	aracteristics (T _C = 25 °C)					
Pulsed Current	I _{SM}				130	Α	
Diode Forward Voltage	V_{SD}	I _F = 20 A, V _{GS} = 0 V 1 1.2		1.2	V		
Reverse Recovery Time t _{rr}		$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$		45	100	ns	

Notes:

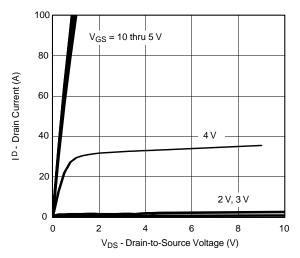
- a. For design aid only; not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

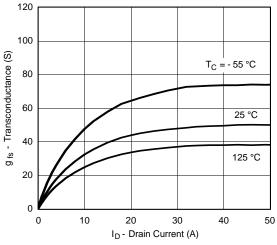




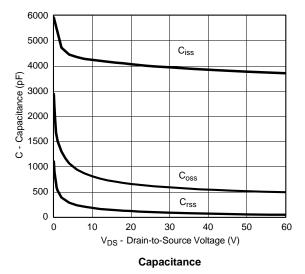
TYPICAL CHARACTERISTICS (25 °C unless noted)

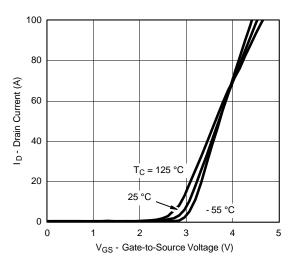


Output Characteristics

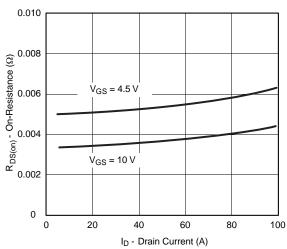


Transconductance

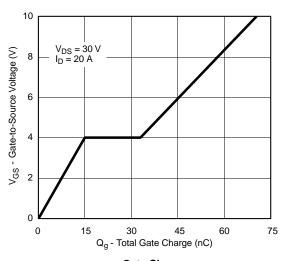




Transfer Characteristics



On-Resistance vs. Drain Current

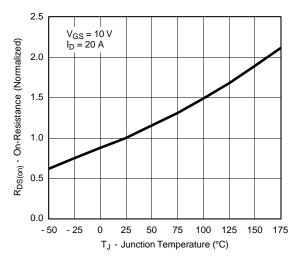


Gate Charge

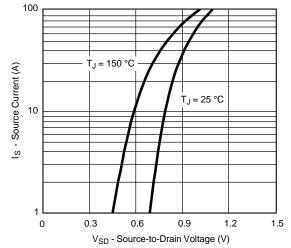




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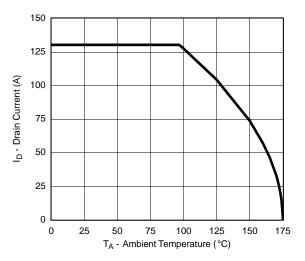
On-Resistance vs. Junction Temperature



Source-Drain Diode Forward Voltage

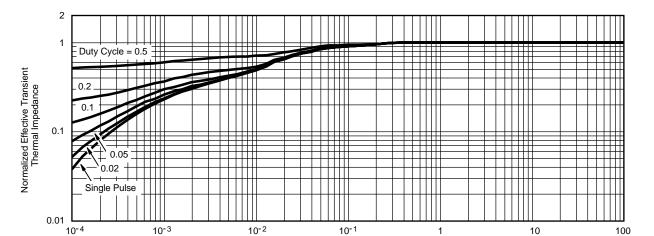


THERMAL RATINGS



1000 Limited by R_{DS(on)*} 10 µs 100 µs 100 Ш 1 ms I_D - Drain Current (A) HH 10 10 ms 100 ms DC T_C = 25 °C Single Pulse 0.1 0.01 - 0.1 100 $V_{DS} - Drain-to-Source \ Voltage \ (V) \\ ^*V_{GS} > minimum \ V_{GS} \ at \ which \ R_{DS(on)} \ is \ specified$ Safe Operating Area

Maximum Drain Current vs. Ambient Temperature

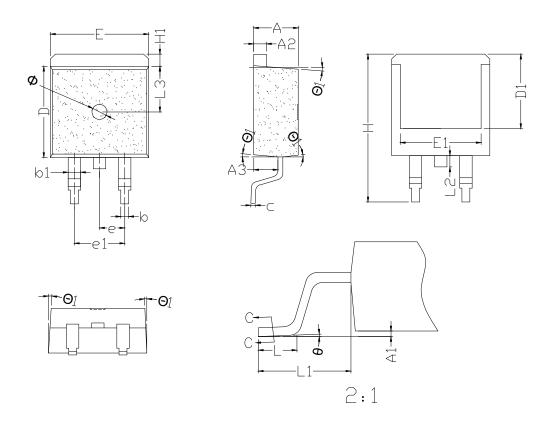


Normalized Thermal Transient Impedance, Junction-to-Case

Square Wave Pulse Duration (s)



TO-263 PACKAGE OUTLINE



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	TYP	MAX	SYMBOL	MIN	TYP	MAX
Α	4.10	4.50	4.80	е	2.35	2.54	2.75
A1	0.00	0.10	0.30	e1	5.08REF		
A2	1.10	1.30	1.50	Н	14.50	16.00	
A3	2.15	2.50	3.10	H1	1.00	1.28	1.75
b	0.60	0.80	1.05	L	1.80	2.23	2.90
b1	1.05	1.33	1.50	L1	4.30	4.75	5.50
С	0.33	0.50	0.66	L2	1.00 1.30 1.85		
D	8.40	9.20	9.60	L3	0.90	4.65	9.00
D1	7.50REF			ф	0°	2°	5°
E	9.60	10.02	10.80	φ1	2°	-	7°
E1	7.60	9.88	10.30	Φ	1.5BSC		





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